

High Power Lamp

Preliminary

EHP-5393/UT01-P01

Features

- Popular 10mm package.
- Color coordinates: x=0.29, y=0.28 according to CIE.
- View angle:25°.
- High light flux output
- Soldering methods: Dip soldering.
- Grouping parameter: total luminous flux, color coordinates.
- Optical efficiency: 35 lm/W
- Thermal resistance (junction to leadframe): 10K/W
- The product itself will remain within RoHS compliant version.
- ESD-withstand voltage: up to 4KV



- The series is specially designed for applications requiring higher brightness.
- The LED lamps are available with different colors, intensities, epoxy colors, etc.

Applications

- Flashlight
- Sunshine light.
- Advertising Signs.
- Back lighting.

Device Selection Guide

LEDD AN	Cł	Lens Color	
LED Part No.	Material	Material Emitted Color	
EHP5393/UT01-P01	InGaN	White	Water Clear

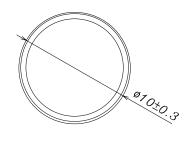


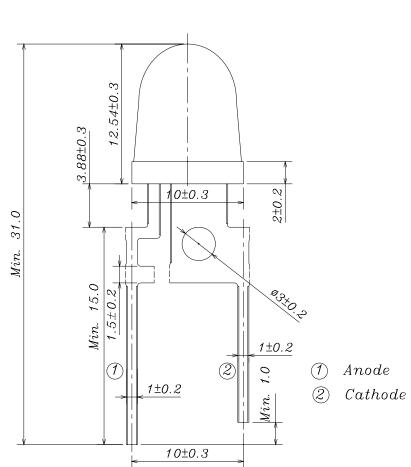
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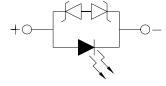
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Package Dimensions







Notes:

- Other dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Protruded resin under flange is 1.5mm Max LED.
- Bare copper alloy is exposed at tie-bar portion after cutting.

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Absolute Maximum Rating $(T_a=25^{\circ}C)$

Parameter	Symbol	Absolute Maximum Rating	Unit
Forward Current	I_{F}	350	mA
Thermal resistance (junction to leadframe)	$R_{ ext{th(j-l)}}$	13	K/W
LED Junction Temperature	Tj	120	$^{\circ}\!\mathbb{C}$
Operating Temperature	Topr	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{stg}	-40 ~ +100	$^{\circ}\!\mathbb{C}$
Electrostatic Discharge	ESD	4K	V
Soldering Temperature	$T_{\rm sol}$	260 ±5	$^{\circ}\!\mathbb{C}$
Power Dissipation	P_d	1.4	W
Zener Reverse Current	Iz	100	mA

Notes: Soldering time ≤ 5 seconds.

Electro-Optical Characteristics ($T_a=25^{\circ}C$)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Flux	Flux	27	37		lm	
Viewing Angle	$2 heta_{ ext{1/2}}$		25		deg	I _F =350mA
Forward Voltage	V_{F}	3.0	3.5	4.0	V	
Reverse Current	I_R			10	μΑ	V _R =5V
Zener Reverse Voltage	Vz	5.2			V	Iz=5mA
Chromaticity Coordinates	Х		0.29			1 250 4
	y		0.28			$I_F=350\text{mA}$

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Rank Combination (I_F=350mA)

Rank	J2	Ј3	J4	J5
Luminous Flux	27~33	33~39	39~45	45~52

^{*}Measurement Uncertainty of Luminous Intensity: ±15%

Unit:lm

Forward Voltage Combination (V at 350mA)

Rank	1	2	3	4	5
Forward Voltage	3.0~3.2	3.2~3.4	3.4~3.6	3.6~3.8	3.8~4.0

^{*}Measurement Uncertainty of Forward Voltage: ±0.1V

Unit:V

Color Combination (at 350mA)

Color Ranks		CIE			
A 1	X	0.245	0.264	0.28	0.26
A1	Y	0.225	0.267	0.248	0.21
A O	X	0.264	0.283	0.296	0.28
A0	Y	0.267	0.305	0.267	0.248
D2	X	0.283	0.304	0.307	0.287
В3	Y	0.305	0.33	0.315	0.295
B4	X	0.304	0.33	0.33	0.307
	Y	0.33	0.36	0.339	0.315
В5	X	0.287	0.307	0.311	0.296
	Y	0.295	0.315	0.294	0.276
В6	X	0.307	0.33	0.33	0.311
	Y	0.315	0.339	0.318	0.294
С0	X	0.33	0.361	0.355	0.33
	Y	0.36	0.385	0.35	0.318

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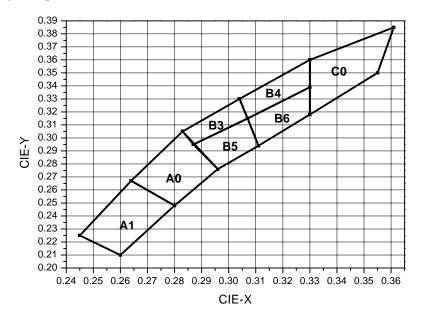


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CIE Chromaticity Diagram



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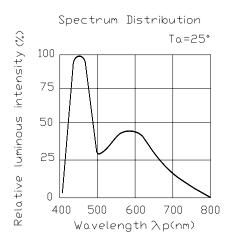


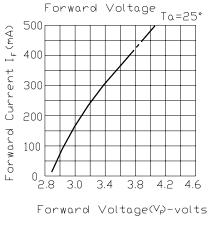
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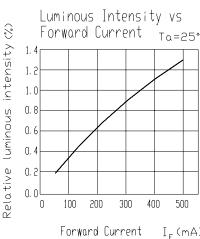
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Typical Electro-Optical Characteristics Curves

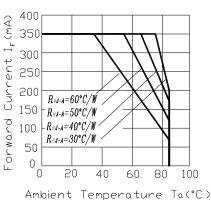


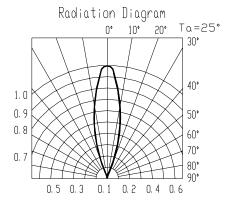


Luminous Intensity vs. Relative luminous intensity (%) Ambient Temperature 1000 100 10 -60 -40 -20 0 20 40 Ambient Temperature Ta(°C)



Forward Current Derating Curve





 $I_{F}(mA)$

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Packing Quantity Specification

1.250PCS/1Bag, 5Bags/1Box

2.10Boxes/1Carton

Label Form Specification

MADE IN TAIWAN

CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Ranks of Total Flux and Forward Voltage

HUE: Color Rank REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

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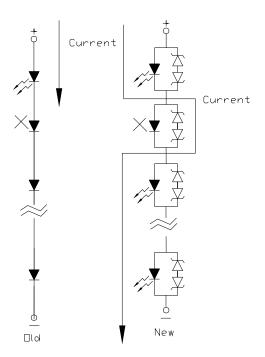
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Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.
- 4. Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- 5. When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up.



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- 6. If the emitter is operated, consider using metal heat sink with the lowest possible thermal resistance. For the thermal performance using a flat heat sink, allow an exposed surface area of about 25mm² at least.
- 7. Soldering Condition

Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to case, and soldering beyond the base of the tie bar is recommended.

Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.

Recommended soldering conditions:

Hand Soldering		DIP Soldering		
Temp. at tip of iron	400°C Max. (30W Max.)	Preheat temp.	100°C Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp.	265 Max.	
Distance	3mm Min.(From solder joint to case)	Bath time.	5 sec Max.	
		Distance	3mm Min.	

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